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HXMH60M105P

N-Channel Power MOSFET

600 V, 31.5 A, 105 mΩ

Description

The 600V FRD series has ultra-fast body diode performance，low on-resistance and reduced gate charge.

It combines the benefits of a fast switching performance with ease of usage and robustness. Additionally, we offer low reverse recovery time (trr) and reverse recovery charge (Qrr) for the bridge structure topology, especially for resonant converters (LLC, PSFB, etc.).

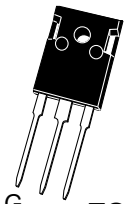
Features

BV_{DSS} @ $T_{J,max}$	I_D	$R_{DS(on),max}$	$Q_{g,typ}$
650 V	31.5 A	105 mΩ	53 nC

- Reduced Switching & Conduction Losses
- Fast Recovery Body-Diode
- Lower Gate Resistance
- 100% Avalanche Tested
- Pb-free and RoHS Compliant
- Compliance with EU REACH

Applications

- Soft Switching Topologies
- Telecom and Sever Power Supplies
- EV Charger and Industrial Power Supplies



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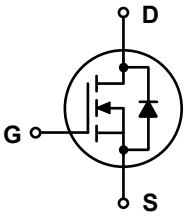


Absolute Maximum Ratings (T_C = 25℃ unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain to Source Voltage		600	V
V_{GSS}	Gate to Source Voltage		±30	V
I_D	Drain Current	Continuous (T_C = 25℃)	31.5	A
		Continuous (T_C = 100℃)	19.9	
I_{DM}	Drain Current	Pulsed (Note1)	94.5	A
E_{AS}	Single Pulsed Avalanche Energy	(Note2)	187	mJ
I_{AS}	Avalanche Current	(Note2)	5.4	A
E_{AR}	Repetitive Avalanche Energy	(Note1)	2.6	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt	(Note3)	50	
P_D	Power Dissipation	(T_C = 25℃)	260	W
		Derate Above 25℃	2.08	W/℃
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to 150	℃
T_L	Maximum Lead Temperature for Soldering, 1/8” from Case for 10 Seconds		260	℃

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.48	℃/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
HXMH60M105P	H60M105P	TO-247AB	Tube	30 units

Electrical Characteristics (T_C = 25℃ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA	600			V
		V_{GS} = 0 V, I_D = 1 mA, T_J = 150℃	650			
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 600 V, V_{GS} = 0 V			10	μA
		V_{DS} = 480 V, V_{GS} = 0 V, T_J = 125℃		20		
I_{GSS}	Gate-Source Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 2.1 mA	3.0		5.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 15.3 A		89	105	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0V, f = 250 kHz		2176		pF
C_{oss}	Output Capacitance			61		pF
$C_{o(tr)}$	Time Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		629		pF
$C_{o(er)}$	Energy Related Output Capacitance			96.3		pF
$Q_{g(tot)}$	Total Gate Charge at 10 V	V_{DS} = 400 V, I_D = 15.3 A, V_{GS} = 10 V		53		nC
Q_{gs}	Gate to Source Charge			13.2		nC
Q_{gd}	Gate to Drain “Miller” Charge			27		nC
R_G	Gate Resistance	f = 1 MHz		1		Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DS} = 400 V, I_D = 15.3 A, V_{GS} = 10 V, R_G = 10 Ω See Figure 13		21		ns
t_r	Turn-On Rise Time			13		ns
$t_{d(off)}$	Turn-Off Delay Time			74		ns
t_f	Turn-Off Fall Time			9		ns
Source-Drain Diode Characteristics						
I_S	Maximum Continuous Diode Forward Current				31.5	A
I_{SM}	Maximum Pulsed Diode Forward Current				94.5	A
V_{SD}	Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 15.3 A			1.2	V
t_{rr}	Reverse Recovery Time	V_{DD} = 400 V, I_{SD} = 15.3 A, dI_F/dt = 100 A/μs		114		ns
Q_{rr}	Reverse Recovery Charge			0.66		μC

※Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. I_{AS} = 5.4 A, R_G = 25 Ω, starting T_J = 25℃.
3. I_{SD} ≤ 15.3 A, di/dt ≤ 100 A/μs, V_{DD} ≤ 400 V, starting T_J = 25℃.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

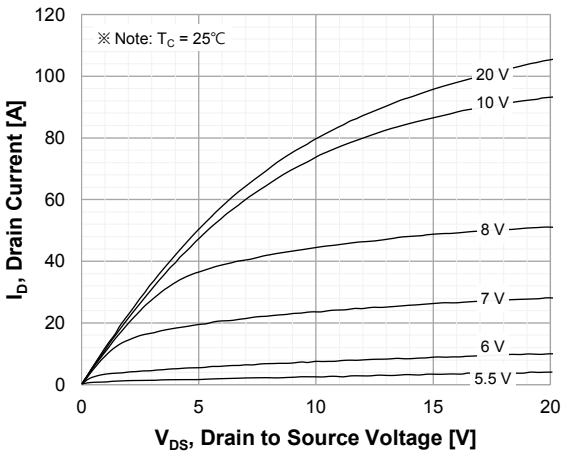


Figure 2. Transfer Characteristics

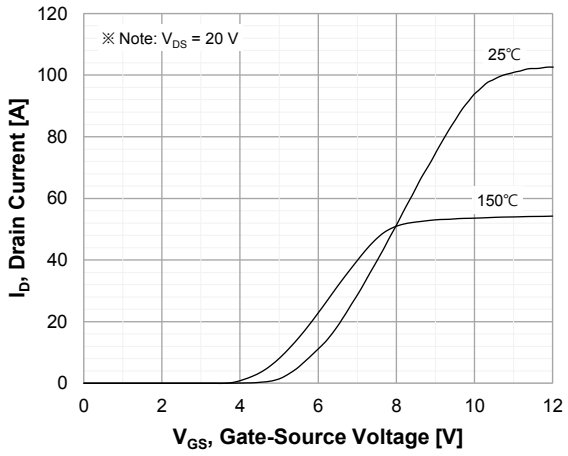


Figure 3. On-Resistance Characteristics vs. Drain Current and Gate Voltage

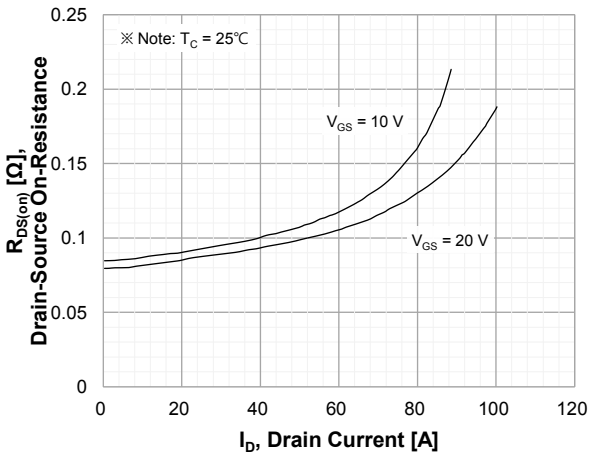


Figure 4. Diode Forward Voltage Characteristics vs. Source-Drain Current and Temperature

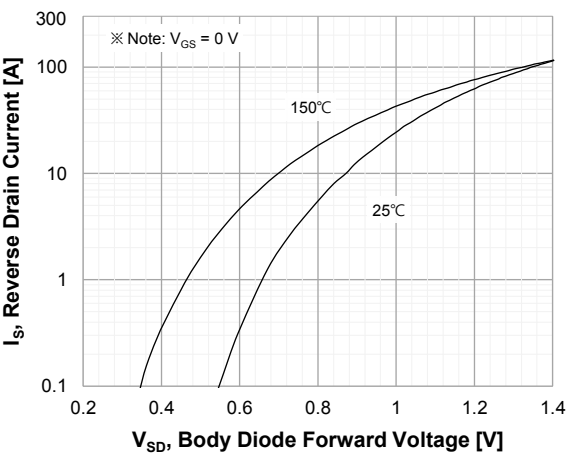


Figure 5. Capacitance Characteristics

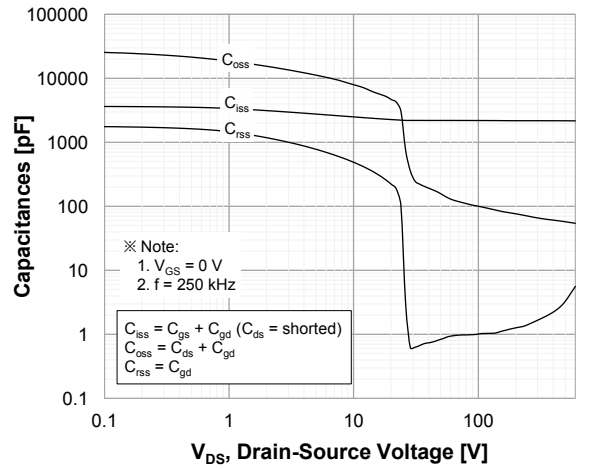
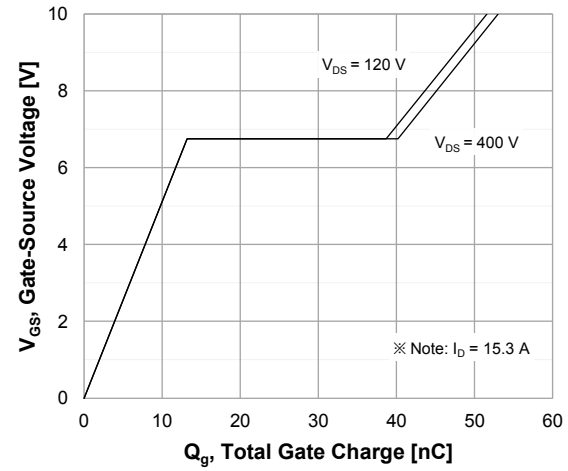


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics

Figure 7. Breakdown Voltage Characteristics vs. Temperature

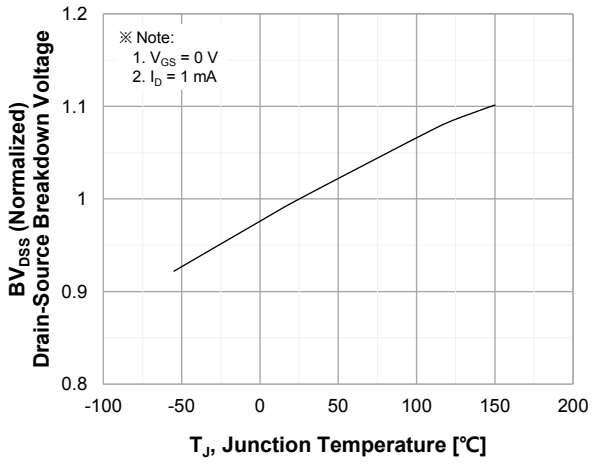


Figure 8. On-Resistance Characteristics vs. Temperature

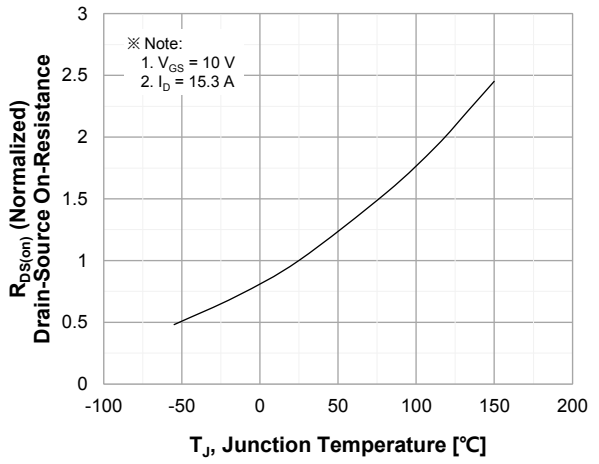


Figure 9. Maximum Safe Operating Area

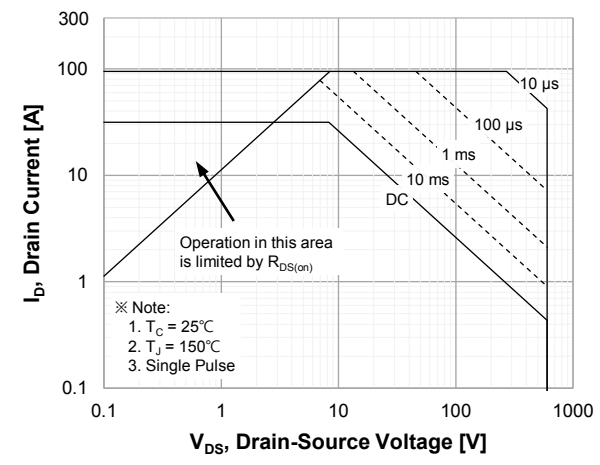


Figure 10. Maximum Drain Current vs. Case Temperature

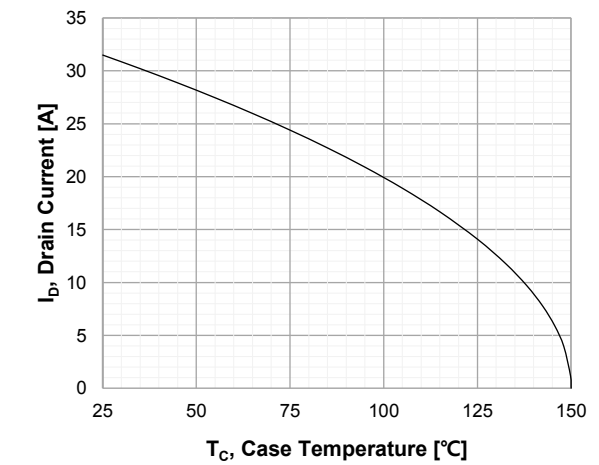


Figure 11. E_{oss} vs. Drain to Source Voltage

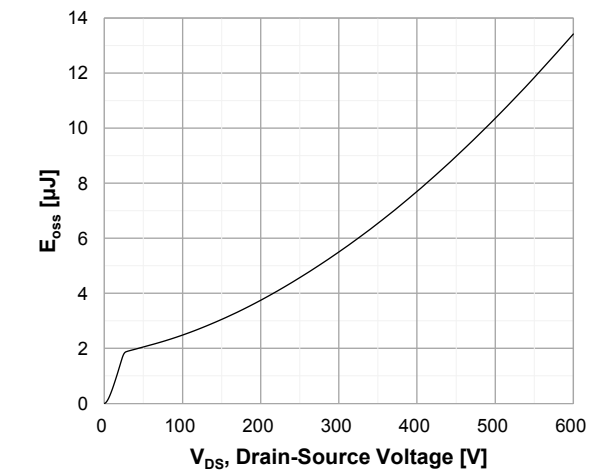
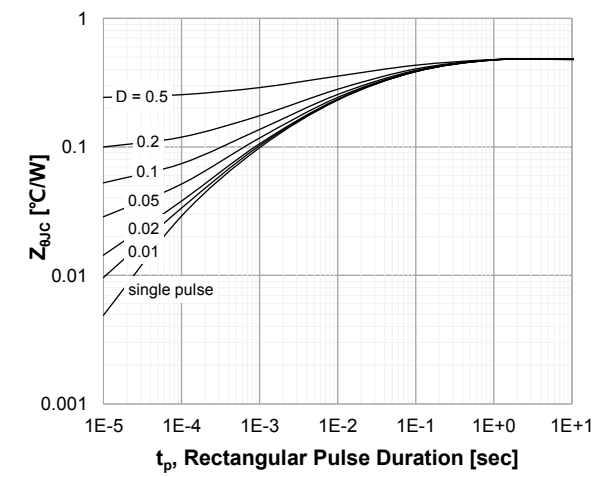


Figure 12. Transient Thermal Response Curve



Test Circuits

Figure 13. Inductive Load Switching Test Circuit and Waveforms

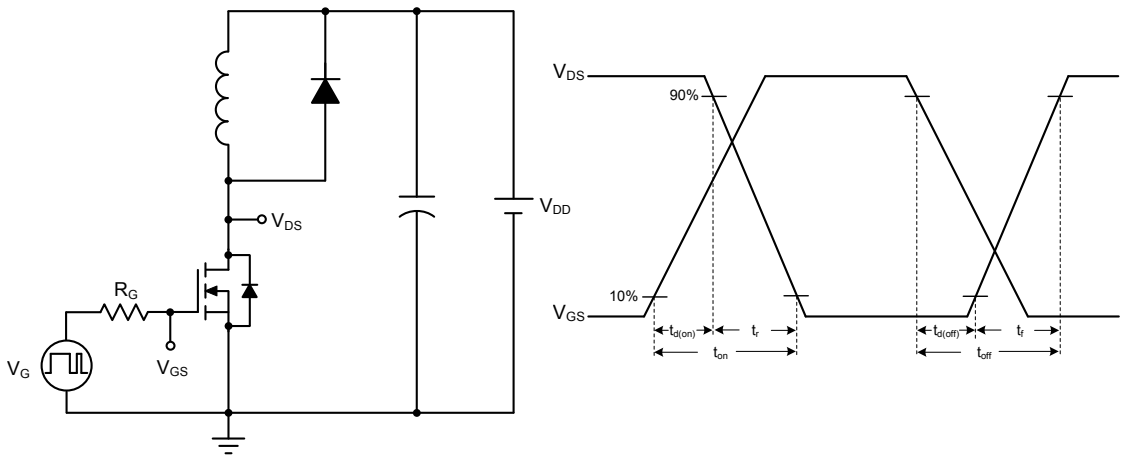


Figure 14. Unclamped Inductive Switching Test Circuit and Waveforms

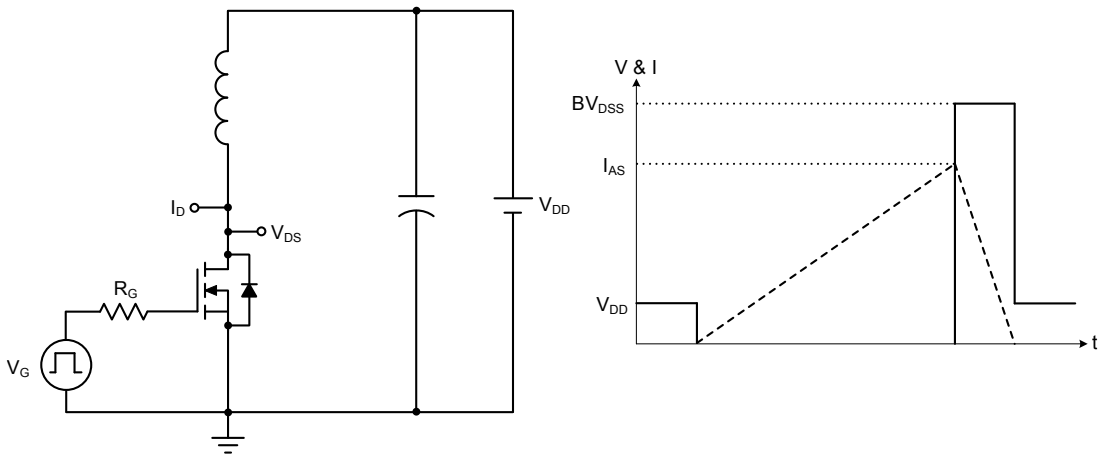
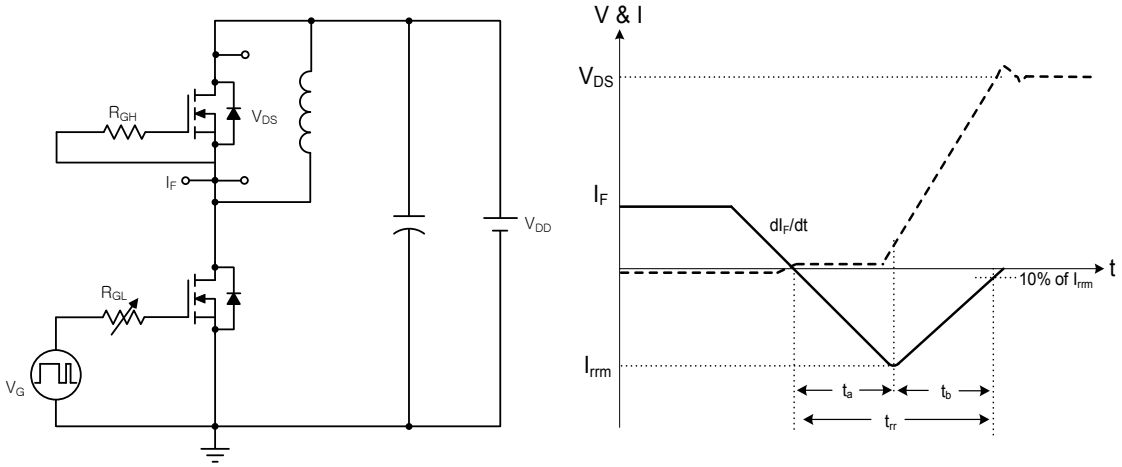


Figure 15. Peak Diode Recovery dv/dt Test Circuit and Waveforms



Package Outlines

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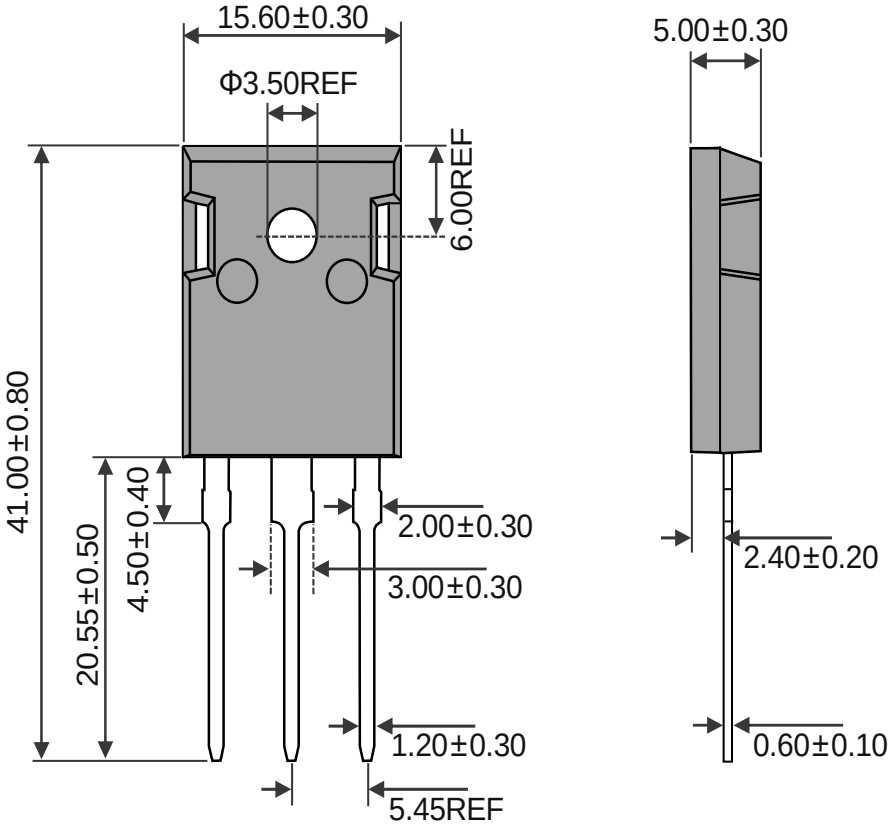

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Unit:mm

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